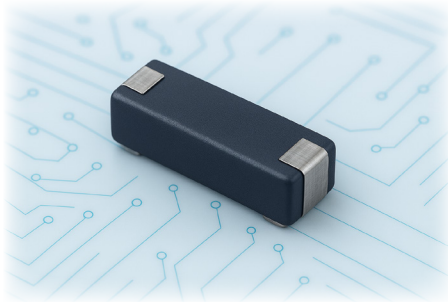


High Reliability Surface Mount Ferrite Bead HRBSM3812S760 (Differential Mode)



Features

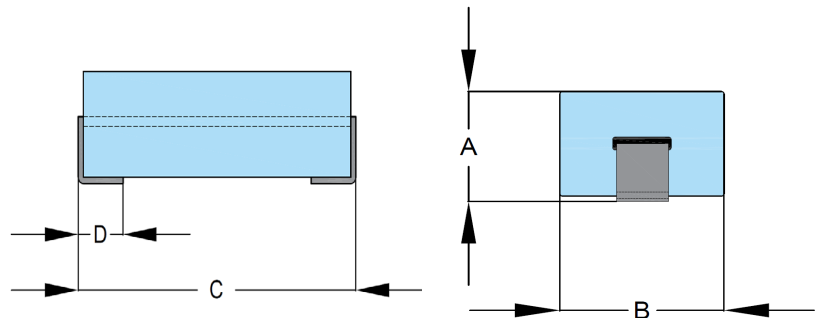
- Oxygen free high conductivity copper and Tin/Lead (Sn/Pb) solder plated terminals.
- Rugged construction with low DC resistance and increased current carrying capacity.
- Terminations are Tin/Lead (Sn/Pb) solder plating over Nickel (Ni) underplating.
- High Reliability with complete material and process traceability.
- Available with DLA 03024 group A, B data are supplied with each shipment.
- Group C inspection data is optional.

Applications

- Satellite/Spacecraft
- Aerospace
- Avionics
- Military
- Telecom DC/DC power
- Drones
- Battery and BMS
- PDU

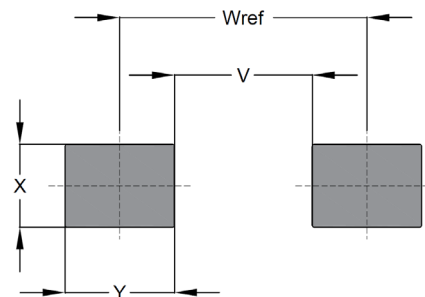
Product Dimensions

Dimension	mm	mm Tol.	Nominal Inch	Inch Misc
A	3.05	Max	0.120	-
B	3.05	± 0.10	0.12	-
C	9.6	Max	0.378	-
D	1.5	± 0.50	0.059	-



Land Pattern

Unit	V	W	X	Y
mm	4.50	7.50	1.80	3.00
Inch	0.177	0.295	0.071	0.118

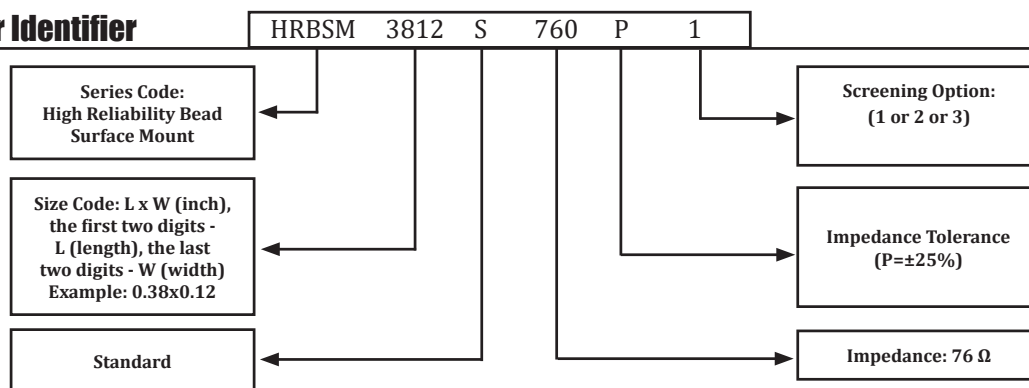


High Reliability Surface Mount Ferrite Bead HRBSM3812S760 (Differential Mode)

Electrical Characteristics and General Specification:

Part Number	HRBSM3812S760P	Max. Current Rating (A)	5 AMP
Typical Impedance (Ω)	76 @ 100MHz 102 @ 250 MHz* 124 @ 500 MHz* 139 @ 1000 MHz	Storage Temperature (°C)	-55 to +125 RH < 55%
		Operating Temperature(°C)	-55 to +125
		Termination	Tin/Lead over nickel undercoating
		Ferrite Material	NiZn (61 Material)
Max. RDC (mΩ)	1.2	Weight (g)	0.3
*Minimum impedance	55 Min. @100MHZ	75 Min. @250MHZ	85 Min. @500MHZ

Part Number Identifier



Standard Screening Options:

- 1- Standard 100% Visual Inspection and electric characteristics (Impedance/DC resistance Read and Record) per DLA 03024.
- 2- Option 2: Group A and B Screening per DLA 03024.
- 3- Option 3: Group A, B, and C Screening per DLA 03024.

Termination :

Tin/Lead (Sn/Pb) solder plating

High Reliability Surface Mount Ferrite Bead HRBSM3812S760 (Differential Mode)

Frequency vs. Impedance (Z) , Resistance (R), Reactance (XL)

